# 74HC74-Q100; 74HCT74-Q100

Dual D-type flip-flop with set and reset; positive edge-trigger

Rev. 3 — 4 December 2015

Product data sheet

### 1. General description

The 74HC74-Q100; 74HCT74-Q100 are dual positive edge triggered D-type flip-flop with individual data (nD), clock (nCP), set (nSD) and reset (nRD) inputs, and complementary nQ and nQ outputs. Data at the nD-input, that meets the set-up and hold time requirements on the LOW-to-HIGH clock transition, will be stored in the flip-flop and appear at the nQ output. The Schmitt-trigger action in the clock input, makes the circuit highly tolerant to slower clock rise and fall times. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of  $V_{CC}$ .

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

### 2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
  - ◆ Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- Input levels:
  - ◆ For 74HC74-Q100: CMOS level
  - ◆ For 74HCT74-Q100: TTL level
- Symmetrical output impedance
- Low power dissipation
- High noise immunity
- Balanced propagation delays
- Specified in compliance with JEDEC standard no. 7A
- ESD protection:
  - MIL-STD-883, method 3015 exceeds 2000 V
  - HBM JESD22-A114F exceeds 2000 V
  - $\bullet$  MM JESD22-A115-A exceeds 200 V (C = 200 pF, R = 0  $\Omega$ )
- Multiple package options

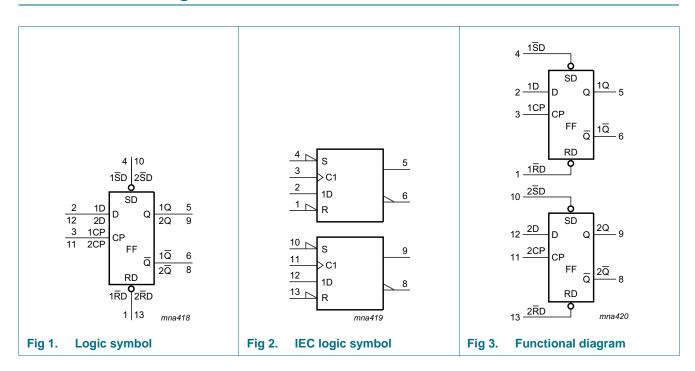


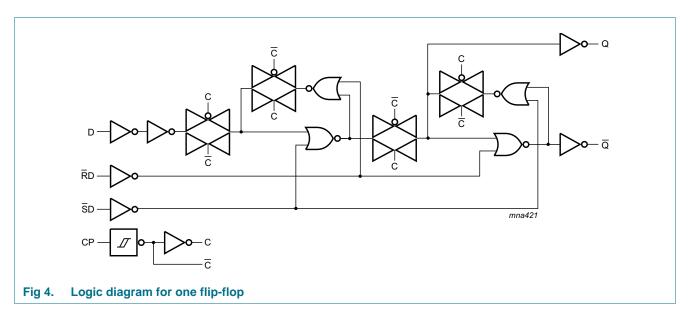
# 3. Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range Name		Description	Version
74HC74D-Q100	−40 °C to +125 °C	SO14	plastic small outline package; 14 leads; body width 3.9 mm	SOT108-1
74HCT74D-Q100	-			
74HC74PW-Q100	-40 °C to +125 °C TSSOP14		plastic thin shrink small outline package;	SOT402-1
74HCT74PW-Q100	-		14 leads; body width 4.4 mm	
74HC74BQ-Q100	-40 °C to +125 °C	DHVQFN14	plastic dual in-line compatible thermal	SOT762-1
74HCT74BQ-Q100			enhanced very thin quad flat package; no leads; 14 terminals; body $2.5 \times 3 \times 0.85$ mm	

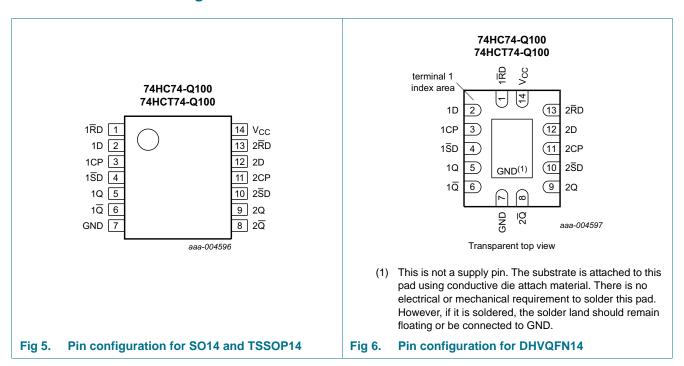
# 4. Functional diagram





### 5. Pinning information

### 5.1 Pinning



## 5.2 Pin description

Table 2. Pin description

Symbol	Pin	Description	
1RD	1	asynchronous reset-direct input (active LOW)	
1D	2	data input	
1CP	3	clock input (LOW-to-HIGH, edge-triggered)	
1SD	4	asynchronous set-direct input (active LOW)	
1Q	5	output	
1Q	6	complement output	
GND	7	ground (0 V)	
2Q	8	complement output	
2Q	9	output	
2SD	10	asynchronous set-direct input (active LOW)	
2CP	11	clock input (LOW-to-HIGH, edge-triggered)	
2D	12	data input	
2RD	13	asynchronous reset-direct input (active LOW)	
V <sub>CC</sub>	14	supply voltage	

## 6. Functional description

Table 3. Function table[1]

Input		Output			
nSD	nRD	nCP	nD	nQ	nQ
L	Н	X	X	Н	L
Н	L	X	X	L	Н
L	L	X	X	Н	Н

<sup>[1]</sup> H = HIGH voltage level; L = LOW voltage level; X = don't care.

Table 4. Function table[1]

Input		Output			
nSD	nRD	nCP	nD	nQ <sub>n+1</sub>	nQ <sub>n+1</sub>
Н	Н	$\uparrow$	L	L	Н
Н	Н	$\uparrow$	Н	Н	L

<sup>[1]</sup> H = HIGH voltage level; L = LOW voltage level; L = LOW to-HIGH transition; L = LOW transition

# 7. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+7	V
I <sub>IK</sub>	input clamping current	$V_{I} < -0.5 \text{ V or } V_{I} > V_{CC} + 0.5 \text{ V}$	-	±20	mA
I <sub>OK</sub>	output clamping current	$V_{O} < -0.5 \text{ V or } V_{O} > V_{CC} + 0.5 \text{ V}$	-	±20	mA
Io	output current	$V_{O} = -0.5 \text{ V to } (V_{CC} + 0.5 \text{ V})$	-	±25	mA
I <sub>CC</sub>	supply current		-	+100	mA
I <sub>GND</sub>	ground current		-100	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	DIP14 package	1] -	750	mW
		SO14, TSSOP14 and DHVQFN14 packages	1] -	500	mW

<sup>[1]</sup> For DIP14 package:  $P_{tot}$  derates linearly with 12 mW/K above 70 °C.

For SO14 packages: Ptot derates linearly with 8 mW/K above 70 °C.

For TSSOP14 packages: Ptot derates linearly with 5.5 mW/K above 60 °C.

For DHVQFN14 packages: Ptot derates linearly with 4.5 mW/K above 60 °C.

## 8. Recommended operating conditions

Table 6. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions	nditions 74HC74-Q100		74F	ICT74-Q	100	Unit	
			Min	Тур	Max	Min	Тур	Max	
V <sub>CC</sub>	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
VI	input voltage		0	-	V <sub>CC</sub>	0	-	V <sub>CC</sub>	V
Vo	output voltage		0	-	V <sub>CC</sub>	0	-	V <sub>CC</sub>	V
T <sub>amb</sub>	ambient temperature		-40	+25	+125	-40	+25	+125	°C
Δt/ΔV	input transition rise and fall rate	$V_{CC} = 2.0 \text{ V}$	-	-	625	-	-	-	ns/V
		V <sub>CC</sub> = 4.5 V	-	1.67	139	-	1.67	139	ns/V
		$V_{CC} = 6.0 \text{ V}$	-	-	83	-	-	-	ns/V

### 9. Static characteristics

Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	$T_{amb} = -40$ °C to +85 °C			T <sub>amb</sub> = -40 °	C to +125 °C	Unit
			Min	Typ[1]	Max	Min	Max	
74HC74-Q100								
$V_{IH}$	HIGH-level	V <sub>CC</sub> = 2.0 V	1.5	1.2	-	1.5	-	V
	input voltage	V <sub>CC</sub> = 4.5 V	3.15	2.4	-	3.15	-	V
		$V_{CC} = 6.0 \text{ V}$	4.2	3.2	-	4.2	-	V

74HC\_HCT74\_Q100

 Table 7.
 Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	T <sub>amb</sub> =	-40 °C to	+85 °C	$T_{amb} = -40$ °C to +125 °C		Unit
			Min	Typ[1]	Max	Min	Max	
V <sub>IL</sub>	LOW-level	V <sub>CC</sub> = 2.0 V	-	0.8	0.5	-	0.5	V
	input voltage	V <sub>CC</sub> = 4.5 V	-	2.1	1.35	-	1.35	V
		$V_{CC} = 6.0 \text{ V}$	-	2.8	1.8	-	1.8	V
V <sub>OH</sub>	HIGH-level	$V_I = V_{IH}$ or $V_{IL}$						
	output voltage	$I_{O} = -4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.84	4.32	-	3.7	-	V
		$I_{O} = -5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	5.34	5.81	-	5.2	-	V
$V_{OL}$	LOW-level	$V_I = V_{IH}$ or $V_{IL}$						
	output voltage	$I_O = 4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	0.15	0.33	-	0.4	V
		$I_O = 5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	0.16	0.33	-	0.4	V
l <sub>l</sub>	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 \text{ V}$	-	-	±1.0	-	±1.0	μА
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0 \text{ V}$	-	-	40	-	80	μΑ
Cı	input capacitance		-	3.5	-	-	-	pF
74HCT7	4-Q100				1			
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	2.0	1.6	-	2.0	-	V
$V_{IL}$	LOW-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	-	1.2	0.8	-	0.8	V
V <sub>OH</sub>	HIGH-level	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 \text{ V}$						
	output voltage	$I_O = -4 \text{ mA}$	3.84	4.32	-	3.7	-	V
V <sub>OL</sub>	LOW-level	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 \text{ V}$						
	output voltage	$I_{O} = 4.0 \text{ mA}$	-	0.15	0.33	-	0.4	V
I <sub>I</sub>	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$	-	-	±1.0	-	±1.0	μА
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5 \text{ V}$	-	-	40	-	80	μΑ
Δl <sub>CC</sub>	additional supply current	$\begin{aligned} &V_{I} = V_{CC} - 2.1 \text{ V;} \\ &\text{other inputs at } V_{CC} \text{ or GND;} \\ &V_{CC} = 4.5 \text{ V to } 5.5 \text{ V;} \\ &I_{O} = 0 \text{ A} \end{aligned}$						
		per input pin; nD, nRD inputs	-	70	315	-	343	μА
		per input pin; nSD, nCP input	-	80	360	-	392	μА
Cı	input capacitance		-	3.5	-	-	-	pF

<sup>[1]</sup> All typical values are measured at  $T_{amb}$  = 25 °C.

# 10. Dynamic characteristics

Table 8. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V);  $C_L = 50 \text{ pF}$  unless otherwise specified; for test circuit see <u>Figure 9</u>.

Symbol	Parameter	Conditions		T <sub>amb</sub>	= -40 °C to	+85 °C	$T_{amb} = -40$	°C to +125 °C	Unit
				Min	Typ[1]	Max	Min	Max	
74HC74	-Q100								
t <sub>pd</sub>	propagation delay	nCP to nQ, n $\overline{Q}$ ; see Figure 7	[2]						
		V <sub>CC</sub> = 2.0 V		-	47	220	-	265	ns
		V <sub>CC</sub> = 4.5 V		-	17	44	-	53	ns
		$V_{CC} = 5 \text{ V}; C_L = 15 \text{ pF}$		-	14	-	-	-	ns
		V <sub>CC</sub> = 6.0 V		-	14	37	-	45	ns
		nSD to nQ, nQ; see Figure 8	[2]						
		V <sub>CC</sub> = 2.0 V		-	50	250	-	300	ns
		V <sub>CC</sub> = 4.5 V		-	18	50	-	60	ns
		$V_{CC} = 5 \text{ V}; C_L = 15 \text{ pF}$		-	15	-	-	-	ns
		V <sub>CC</sub> = 6.0 V		-	14	43	-	51	ns
		$\overline{RD}$ to $\overline{nQ}$ ; see Figure 8	[2]						
		V <sub>CC</sub> = 2.0 V		-	52	250	-	300	ns
		V <sub>CC</sub> = 4.5 V		-	19	50	-	60	ns
		$V_{CC} = 5 \text{ V}; C_L = 15 \text{ pF}$		-	16	-	-	-	ns
		V <sub>CC</sub> = 6.0 V		-	15	43	-	51	ns
t <sub>t</sub>	transition	nQ, nQ; see Figure 7	[3]						
	time	V <sub>CC</sub> = 2.0 V		-	19	95	-	110	ns
		V <sub>CC</sub> = 4.5 V		-	7	19	-	22	ns
		V <sub>CC</sub> = 6.0 V		-	6	16	-	19	ns
t <sub>W</sub>	pulse width	nCP HIGH or LOW; see Figure 7							
		V <sub>CC</sub> = 2.0 V		100	19	-	120	-	ns
		V <sub>CC</sub> = 4.5 V		20	7	-	24	-	ns
		V <sub>CC</sub> = 6.0 V		17	6	-	20	-	ns
		nSD, nRD LOW; see Figure 8							
		V <sub>CC</sub> = 2.0 V		100	19	-	120	-	ns
		V <sub>CC</sub> = 4.5 V		20	7	-	24	-	ns
		V <sub>CC</sub> = 6.0 V		17	6	-	20	-	ns
t <sub>rec</sub>	recovery	nSD, nRD; see Figure 8							
	time	V <sub>CC</sub> = 2.0 V		40	3	-	45	-	ns
		V <sub>CC</sub> = 4.5 V		8	1	-	9	-	ns
		V <sub>CC</sub> = 6.0 V		7	1	-	8	-	ns

 Table 8.
 Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V);  $C_L = 50 \text{ pF}$  unless otherwise specified; for test circuit see Figure 9.

Symbol	Parameter	Conditions		T <sub>amb</sub> :	= –40 °C to	+85 °C	$T_{amb} = -40$	°C to +125 °C	Unit
				Min	Typ[1]	Max	Min	Max	
t <sub>su</sub>	set-up time	nD to nCP; see Figure 7							
		V <sub>CC</sub> = 2.0 V		75	6	-	90	-	ns
		V <sub>CC</sub> = 4.5 V		15	2	-	18	-	ns
		V <sub>CC</sub> = 6.0 V		13	2	-	15	-	ns
t <sub>h</sub>	hold time	nD to nCP; see Figure 7							
		V <sub>CC</sub> = 2.0 V		3	-6	-	3	-	ns
		V <sub>CC</sub> = 4.5 V		3	-2	-	3	-	ns
		V <sub>CC</sub> = 6.0 V		3	-2	-	3	-	ns
f <sub>max</sub>	maximum	nCP; see Figure 7							
	frequency	V <sub>CC</sub> = 2.0 V		4.8	23	-	4.0	-	MHz
		V <sub>CC</sub> = 4.5 V		24	69	-	20	-	MHz
		$V_{CC} = 5 \text{ V}; C_L = 15 \text{ pF}$		-	76	-	-	-	MHz
		V <sub>CC</sub> = 6.0 V		28	82	-	24	-	MHz
C <sub>PD</sub>	power dissipation capacitance	$C_L$ = 50 pF; f = 1 MHz; $V_I$ = GND to $V_{CC}$	[4]	-	24	-	-	-	pF
74HCT7	4-Q100								
t <sub>pd</sub>	propagation delay	nCP to nQ, nQ; see Figure 7	[2]						
		V <sub>CC</sub> = 4.5 V		-	18	44	-	53	ns
		$V_{CC} = 5 \text{ V}; C_L = 15 \text{ pF}$		-	15	-	-	-	ns
		$\overline{NSD}$ to $\overline{NQ}$ ; see Figure 8	[2]						
		V <sub>CC</sub> = 4.5 V		-	23	50	-	60	ns
		$V_{CC} = 5 \text{ V}; C_L = 15 \text{ pF}$		-	18	-	-	-	ns
		nRD to nQ, nQ; see Figure 8	[2]						
		V <sub>CC</sub> = 4.5 V		-	24	50	-	60	ns
		$V_{CC} = 5 \text{ V}; C_L = 15 \text{ pF}$		-	18	-	-	-	ns
t <sub>t</sub>	transition	nQ, nQ; see Figure 7	[3]						
	time	V <sub>CC</sub> = 4.5 V		-	7	19	-	22	ns
t <sub>W</sub>	pulse width	nCP HIGH or LOW; see Figure 7							
		V <sub>CC</sub> = 4.5 V		23	9	-	27	-	ns
		nSD, nRD LOW; see <u>Figure 8</u>							
		V <sub>CC</sub> = 4.5 V		20	9	-	24	-	ns
t <sub>rec</sub>	recovery	nSD, nRD; see Figure 8							
	time	V <sub>CC</sub> = 4.5 V		8	1	-	9	-	ns
t <sub>su</sub>	set-up time	nD to nCP; see Figure 7							
		V <sub>CC</sub> = 4.5 V		15	5	-	18	-	ns

74HC\_HCT74\_Q100

#### Table 8. Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V);  $C_L = 50 pF$  unless otherwise specified; for test circuit see <u>Figure 9</u>.

Symbol	Parameter	Conditions	T <sub>amb</sub> =	= –40 °C to	+85 °C	T <sub>amb</sub> = -40	°C to +125 °C	Unit
			Min	Typ[1]	Max	Min	Max	
t <sub>h</sub>	hold time	nD to nCP; see Figure 7						
		V <sub>CC</sub> = 4.5 V	3	-3	-	3	-	ns
f <sub>max</sub>	maximum	nCP; see Figure 7						
	frequency	V <sub>CC</sub> = 4.5 V	22	54	-	18	-	MHz
		V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF	-	59	-	-	-	MHz
C <sub>PD</sub>	power dissipation capacitance	$C_L = 50 \text{ pF; } f = 1 \text{ MHz;}$ $V_I = \text{GND to } V_{CC} - 1.5 \text{ V}$	-	29	-	-	-	pF

- [1] All typical values are measured at  $T_{amb}$  = 25 °C.
- [2]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .
- [3]  $t_t$  is the same as  $t_{THL}$  and  $t_{TLH}$ .
- [4]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o)$$
 where:

 $f_i$  = input frequency in MHz;

fo = output frequency in MHz;

C<sub>L</sub> = output load capacitance in pF;

V<sub>CC</sub> = supply voltage in V;

N = number of inputs switching;

 $\sum (C_L \times V_{CC}^2 \times f_o) = \text{sum of outputs.}$ 

### 11. Waveforms

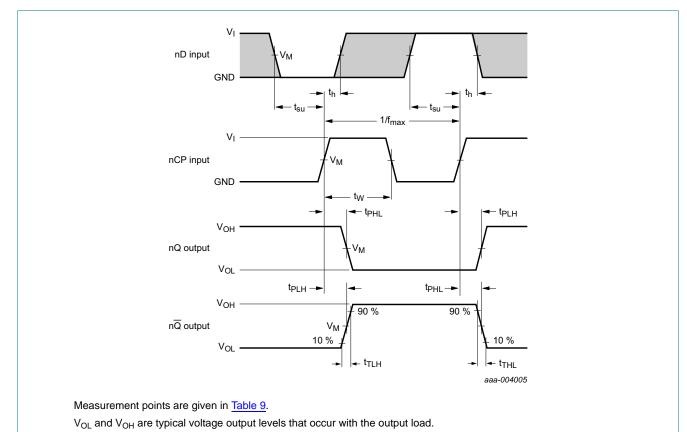
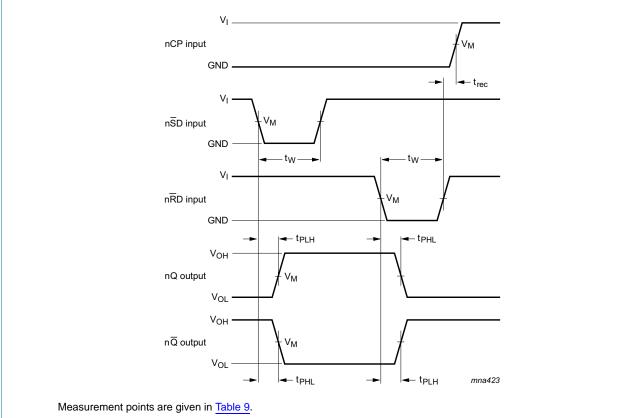


Fig 7. Propagation delay input (CP) to output (Qn), output transition time, clock input (CP) pulse width and the maximum frequency (CP)

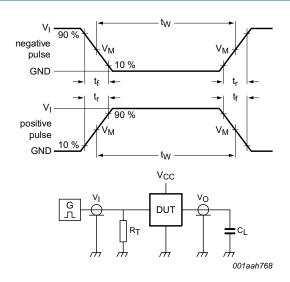


 $\ensuremath{V_{\text{OL}}}$  and  $\ensuremath{V_{\text{OH}}}$  are typical voltage output levels that occur with the output load.

Fig 8. The set (nSD) and reset (nRD) input to output (nQ,nQ) propagation delays, set and reset pulse widths and the nSD, nRD to nCP recovery time

Table 9. Measurement points

Туре	Input	Output
	V <sub>M</sub>	V <sub>M</sub>
74HC74-Q100	0.5V <sub>CC</sub>	0.5V <sub>CC</sub>
74HCT74-Q100	1.3 V	1.3 V



Test data is given in Table 10.

Definitions test circuit:

 $R_T$  = Termination resistance should be equal to output impedance  $Z_0$  of the pulse generator.

 $C_L$  = Load capacitance including jig and probe capacitance.

 $R_L$  = Load resistance.

S1 = Test selection switch.

Fig 9. Test circuit for measuring switching times

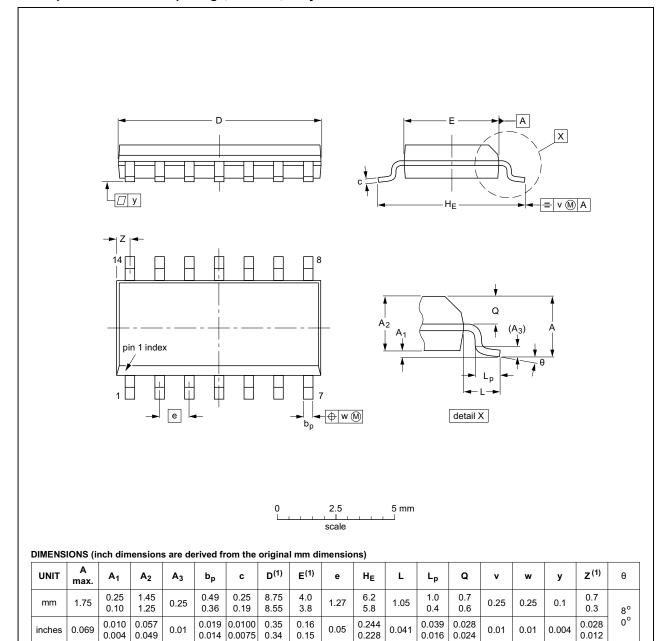
Table 10. Test data

Туре	Input		Load	Test	
	VI	t <sub>r</sub> , t <sub>f</sub>	C <sub>L</sub>	R <sub>L</sub>	
74HC74-Q100	V <sub>CC</sub>	6 ns	15 pF, 50 pF	1 kΩ	t <sub>PLH</sub> , t <sub>PHL</sub>
74HCT74-Q100	3 V	6 ns	15 pF, 50 pF	1 kΩ	t <sub>PLH</sub> , t <sub>PHL</sub>

# 12. Package outline

#### SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



#### Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC JEITA				PROJECTION
SOT108-1	076E06	MS-012				<del>99-12-27</del> 03-02-19

Fig 10. Package outline SOT108-1 (SO14)

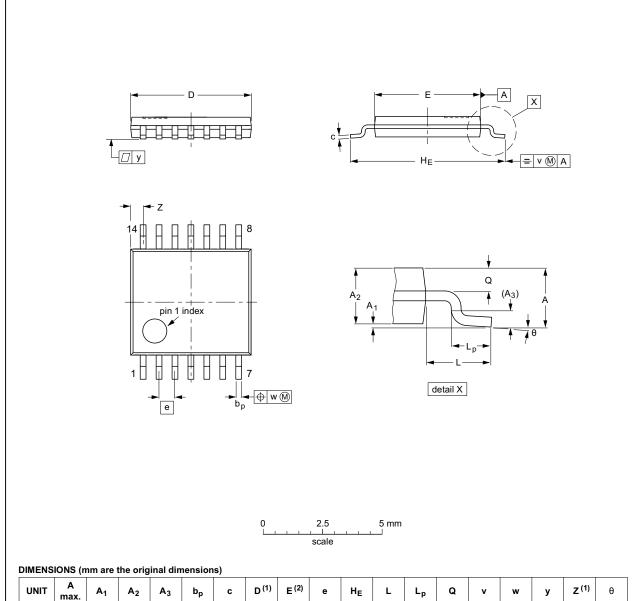
74HC\_HCT74\_Q100

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TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1



							-,												
ι	JNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	С	D (1)	E (2)	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
	mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.72 0.38	8° 0°

#### Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

	REFER	EUROPEAN	ISSUE DATE			
IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
	MO-153				<del>99-12-27</del> 03-02-18	
	IEC	IEC JEDEC	IEC JEDEC JEITA	IEC JEDEC JEITA	IEC JEDEC JEITA PROJECTION	

Fig 11. Package outline SOT402-1 (TSSOP14)

74HC\_HCT74\_Q100

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DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body  $2.5 \times 3 \times 0.85$  mm

SOT762-1

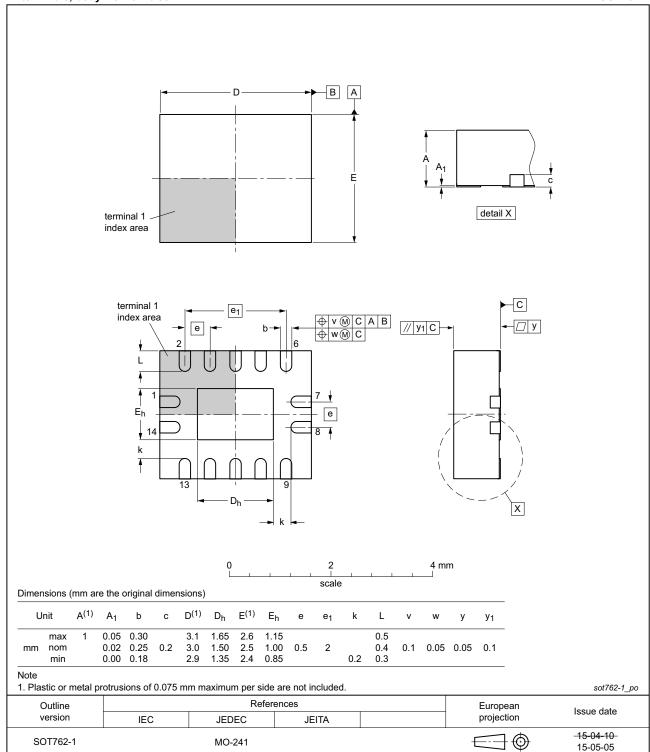


Fig 12. Package outline SOT762-1 (DHVQFN14)

74HC\_HCT74\_Q100

# 13. Abbreviations

#### Table 11. Abbreviations

Acronym	Description
CMOS	Complementary Metal Oxide Semiconductor
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MIL	Military
MM	Machine Model
TTL	Transistor-Transistor Logic

# 14. Revision history

#### Table 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74HC_HCT74_Q100 v.3	20151204	Product data sheet	-	74HC_HCT74_Q100 v.2
Modifications:	Type number	er 74HC74N-Q100 (SOT27	7-1) removed.	
74HC_HCT74_Q100 v.2	20130906	Product data sheet	-	74HC_HCT74_Q100 v.1
Modifications:	• 74HC74N-0	0100 (DIP14) added.		
74HC_HCT74_Q100 v.1	20120807	Product data sheet	-	-

### 15. Legal information

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Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nexperia.com.

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# 74HC74-Q100; 74HCT74-Q100

### Dual D-type flip-flop with set and reset; positive edge-trigger

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## 17. Contents

General description 1
Features and benefits
Ordering information 2
Functional diagram 2
Pinning information
Pinning
Pin description 4
Functional description 4
Limiting values 5
Recommended operating conditions 5
Static characteristics 5
Dynamic characteristics 7
Waveforms
Package outline
Abbreviations
Revision history 16
Legal information
Data sheet status
Definitions
Disclaimers
Trademarks
Contact information
Contents